

TOREX SEMICONDUCTOR LTD.
Quality Assurance Dept.

Composition Table

Product(Pb-free): XC6220xxxxMR-G
Typical Mass: 16 mg

Part name	Weight(mg)	Material name	Ratio(ppm)	CAS number
Silicon chip	0.606	Silicon	37900	7440-21-3
		- Arsenic	<1	7440-38-2
Leadframe	5.503	Copper	343900	7440-50-8
		Tin	1400	7440-31-5
		Zinc	1300	7440-66-6
		Chromium	1500	7440-47-3
		Silver	20300	7440-22-4
Die attach	0.049	Silver	3100	7440-22-4
		Epoxy	600	—
Bonding wire	0.185	Gold	11600	7440-57-5
Resin	7.239	Silica	452400	60676-86-0
		Epoxy resin	43000	—
		Phenol resin	36200	—
		Metal hydroxide	25700	—
Plating	0.340	Tin	21300	7440-31-5

* The component composition is based on the information provided by raw material vender.

* The mass of the IC and its fractions could be different due to the manufacturing conditions of materials.

* Any indication "-" in CAS number means "confidential."